## General Description

The WSD3028DN is the highest performance trench N-ch MOSFET with extreme high cell density,which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The WSD3028DN meet the RoHS and Green Product requirement 100% EAS guaranteed with full function reliability approved.

## Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

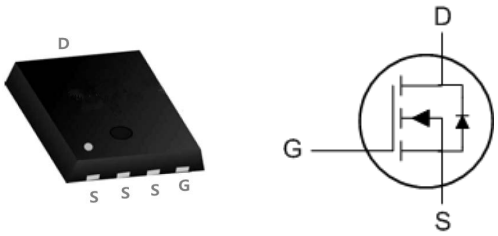
## Product Summery

| BVDSS | RDSON | ID |
|---|---|---|
| 30V | 25mΩ | 19A |

## Applications

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

## DFN3.3X3.3-8L Pin Configuration




## Absolute Maximum Ratings

| Symbol | Parameter | Rating | Units |
|---|---|---|---|
| $V_{DS}$ | Drain-Source Voltage | 30 | V |
| $V_{GS}$ | Gate-Source Voltage | ±20 | V |
| $I_D$@$T_C$=25℃ | Continuous Drain Current, $V_{GS}$ @ 10V[1] | 25 | A |
| $I_D$@$T_C$=100℃ | Continuous Drain Current, $V_{GS}$ @ 10V[1] | 18 | A |
| $I_D$@$T_A$=25℃ | Continuous Drain Current, $V_{GS}$ @ 10V[1] | 19 | A |
| $I_D$@$T_A$=70℃ | Continuous Drain Current, $V_{GS}$ @ 10V[1] | 15 | A |
| $I_{DM}$ | Pulsed Drain Current[2] | 40 | A |
| EAS | Single Pulse Avalanche Energy[3] | 21 | mJ |
| $I_{AS}$ | Avalanche Current | 15 | A |
| $P_D$@$T_C$=25℃ | Total Power Dissipation[4] | 5 | W |
| $P_D$@$T_A$=25℃ | Total Power Dissipation[4] | 2.5 | W |
| $T_{STG}$ | Storage Temperature Range | -55 to 150 | ℃ |
| $T_J$ | Operating Junction Temperature Range | -55 to 150 | ℃ |

## Thermal Data

| Symbol | Parameter | Typ. | Max. | Unit |
|---|---|---|---|---|
| $R_{\theta JA}$ | Thermal Resistance Junction-Ambient [1] | --- | 50 | ℃/W |
| $R_{\theta JC}$ | Thermal Resistance Junction-Case[1] | --- | 4 | ℃/W |

## Electrical Characteristics ($T_J$=25 ℃, unless otherwise noted)

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|---|---|---|---|---|---|---|
| $BV_{DSS}$ | Drain-Source Breakdown Voltage | $V_{GS}$=0V , $I_D$=250uA | 30 | --- | --- | V |
| $\triangle BV_{DSS}/\triangle T_J$ | BVDSS Temperature Coefficient | Reference to 25℃ , $I_D$=1mA | --- | 0.0232 | --- | V/℃ |
| $R_{DS(ON)}$ | Static Drain-Source On-Resistance[2] | $V_{GS}$=10V , $I_D$=12A | --- | 22 | 25 | mΩ |
| | | $V_{GS}$=4.5V , $I_D$=8A | --- | 32 | 35 | |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{GS}$=$V_{DS}$ , $I_D$ =250uA | 1.2 | 1.6 | 2.5 | V |
| $\triangle V_{GS(th)}$ | $V_{GS(th)}$ Temperature Coefficient | | --- | -6.08 | --- | mV/℃ |
| $I_{DSS}$ | Drain-Source Leakage Current | $V_{DS}$=24V , $V_{GS}$=0V , $T_J$=25℃ | --- | --- | 1 | uA |
| | | $V_{DS}$=24V , $V_{GS}$=0V , $T_J$=55℃ | --- | --- | 5 | |
| $I_{GSS}$ | Gate-Source Leakage Current | $V_{GS}$=±20V , $V_{DS}$=0V | --- | --- | ±100 | nA |
| gfs | Forward Transconductance | $V_{DS}$=10V , $I_D$=6A | --- | 6.5 | --- | S |
| $R_g$ | Gate Resistance | $V_{DS}$=0V , $V_{GS}$=0V , f=1MHz | --- | 2.5 | 3.3 | Ω |
| $Q_g$ | Total Gate Charge (4.5V) | $V_{DS}$=15V , $V_{GS}$=4.5V , $I_D$=6A | --- | 4.1 | --- | nC |
| $Q_{gs}$ | Gate-Source Charge | | --- | 1 | --- | |
| $Q_{gd}$ | Gate-Drain Charge | | --- | 2.1 | --- | |
| $T_{d(on)}$ | Turn-On Delay Time | $V_{DD}$=15V , $V_{GEN}$=10V , $R_G$=6Ω $I_D$=1A ,$R_L$=15Ω | --- | 2 | --- | ns |
| $T_r$ | Rise Time | | --- | 4 | --- | |
| $T_{d(off)}$ | Turn-Off Delay Time | | --- | 15.8 | --- | |
| $T_f$ | Fall Time | | --- | 4 | --- | |
| $C_{iss}$ | Input Capacitance | $V_{DS}$=15V , $V_{GS}$=0V , f=1MHz | --- | 360 | --- | pF |
| $C_{oss}$ | Output Capacitance | | --- | 55 | --- | |
| $C_{rss}$ | Reverse Transfer Capacitance | | --- | 46 | --- | |

## Guaranteed Avalanche Characteristics

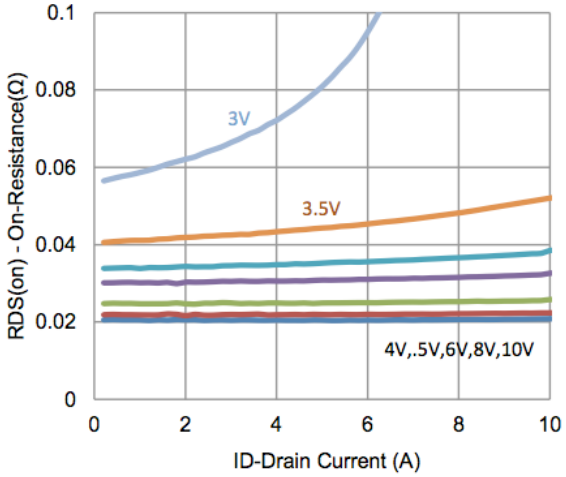
| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|---|---|---|---|---|---|---|
| EAS | Single Pulse Avalanche Energy[5] | $V_{DD}$=25V , L=0.1mH , $I_{AS}$=23A | 21 | --- | --- | mJ |

## Diode Characteristics

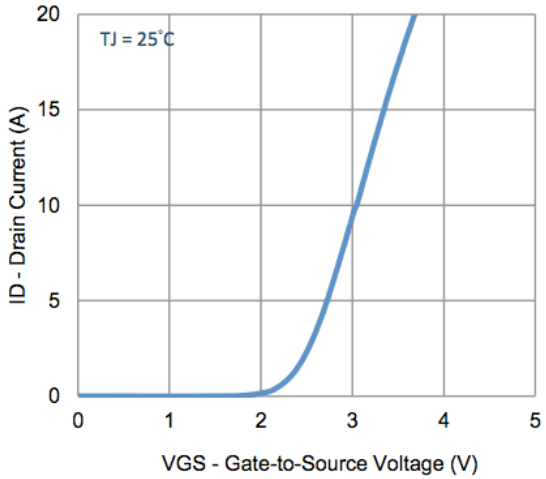
| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|---|---|---|---|---|---|---|
| $I_S$ | Continuous Source Current[1,6] | $V_G$=$V_D$=0V , Force Current | --- | --- | 5 | A |
| $I_{SM}$ | Pulsed Source Current[2,6] | | --- | --- | 22 | A |
| $V_{SD}$ | Diode Forward Voltage[2] | $V_{GS}$=0V , $I_S$=1A , $T_J$=25℃ | --- | --- | 1 | V |
| $t_{rr}$ | Reverse Recovery Time | $I_F$=20A,dI/dt=100A/μs,$T_J$=25℃ | --- | 16.5 | --- | nS |
| $Q_{rr}$ | Reverse Recovery Charge | | --- | 10 | --- | nC |

Note :
1.The data tested by surface mounted on a 1 inch$^2$ FR-4 board with 2OZ copper,t<10sec.
2.The data tested by pulsed , pulse width ≦ 300us , duty cycle ≦ 2%
3.The EAS data shows Max. rating . The test condition is $V_{DD}$=25V,$V_{GS}$=10V,L=0.1mH,$I_{AS}$=23A
4.The power dissipation is limited by 150℃ junction temperature
5.The Min. value is 100% EAS tested guarantee.
6.The data is theoretically the same as $I_D$ and $I_{DM}$ , in real applications , should be limited by total power dissipation.

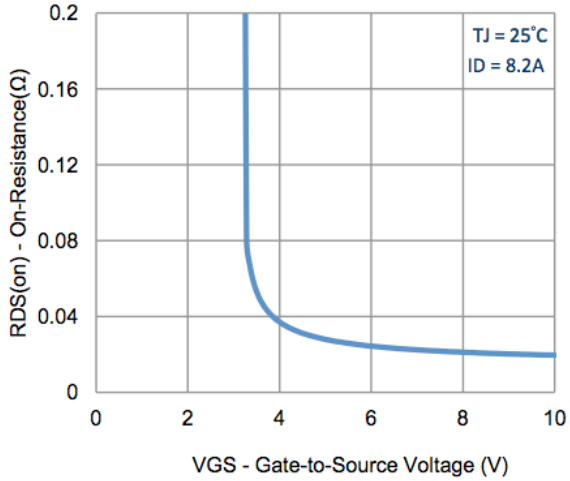
## Typical Characteristics



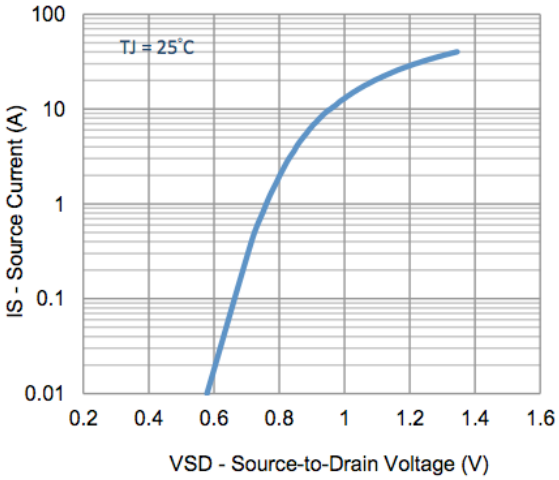

**1. On-Resistance vs. Drain Current**



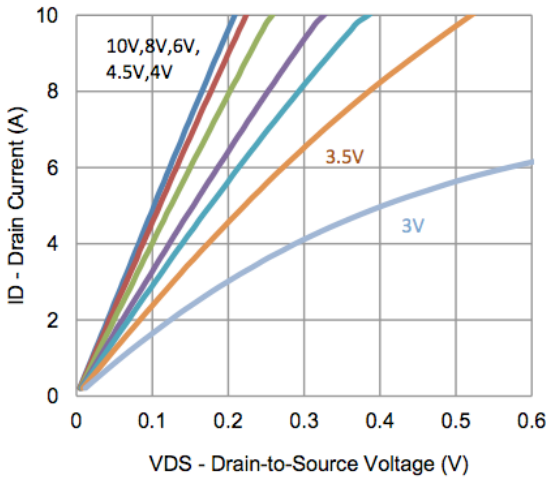

**2. Transfer Characteristics**



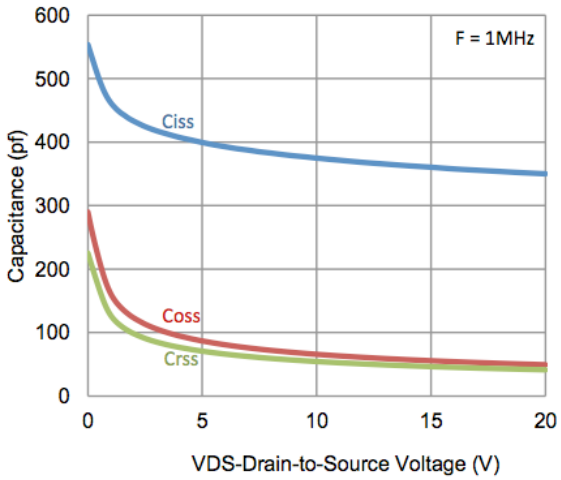

**3. On-Resistance vs. Gate-to-Source Voltage**



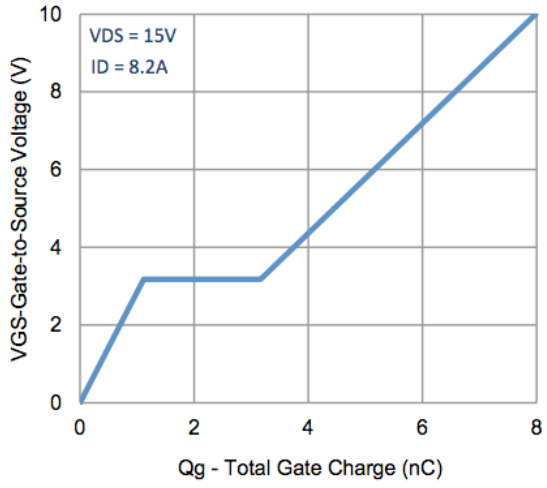

**4. Drain-to-Source Forward Voltage**



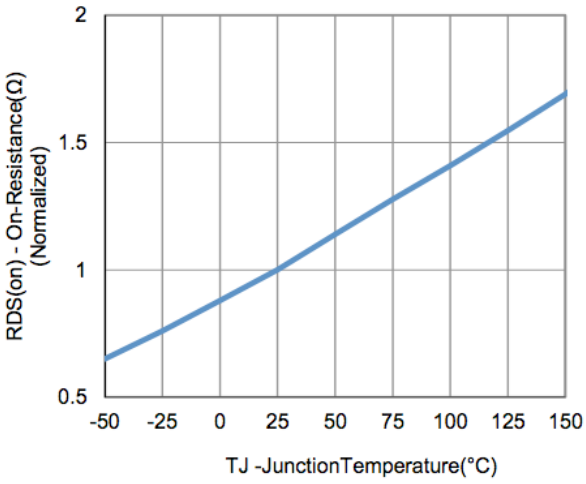

**5. Output Characteristics**



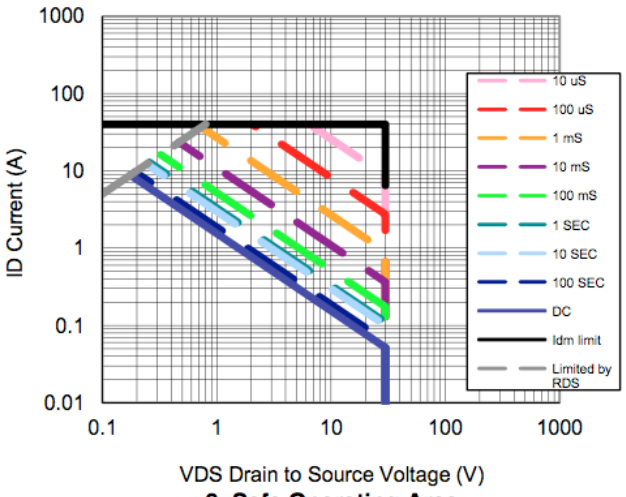

**6. Capacitance**



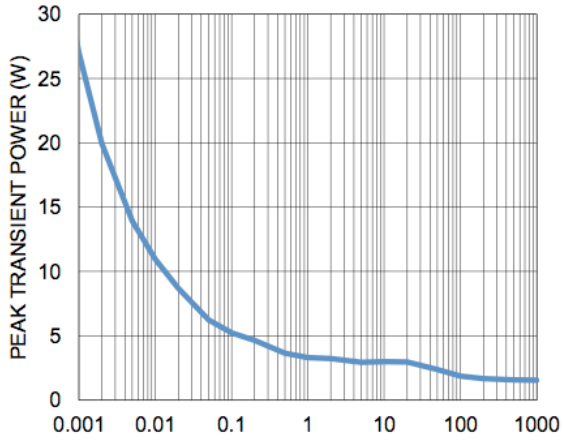

**7. Gate Charge**



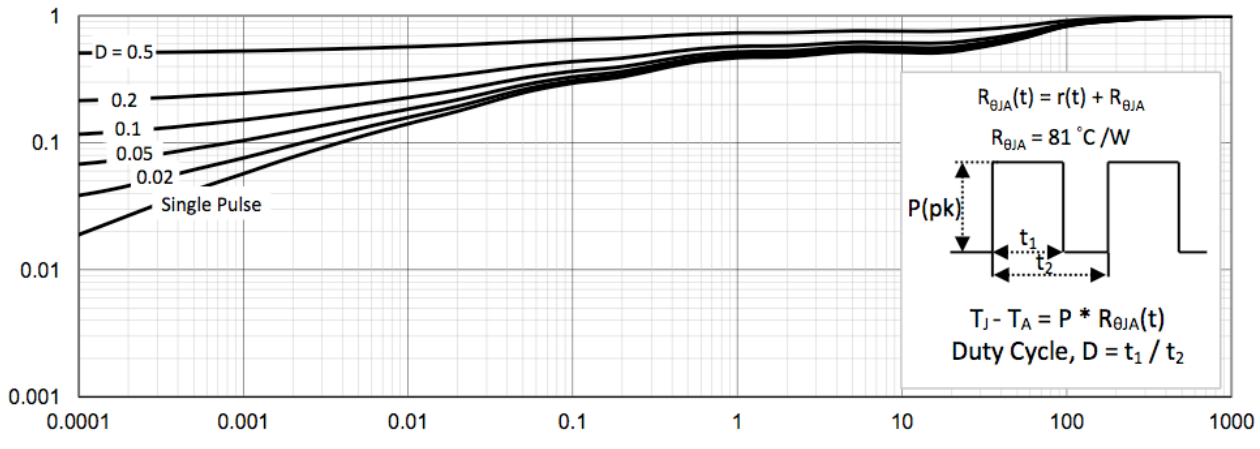

**8. Normalized On-Resistance Vs Junction Temperature**




**9. Safe Operating Area**




**10. Single Pulse Maximum Power Dissipation**




**11. Normalized Thermal Transient Junction to Ambient**

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